

/ Descriptions

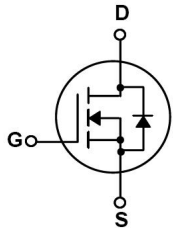
/ Features

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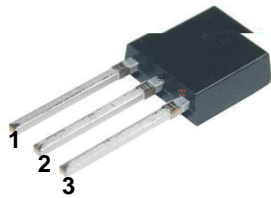
/ Applications

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/ Equivalent Circuit



/ Pinning

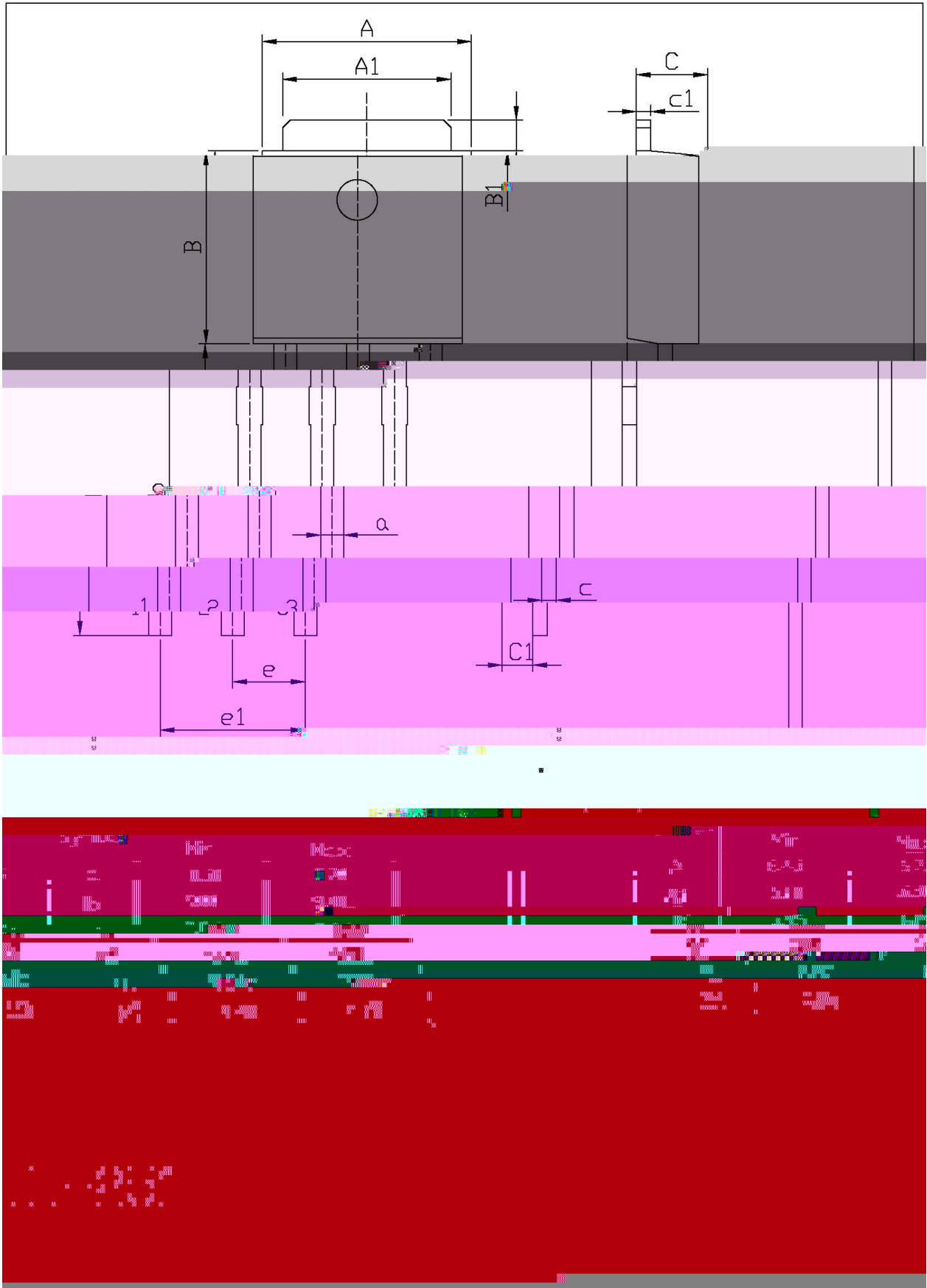


/ h_{FE} Classifications & Marking

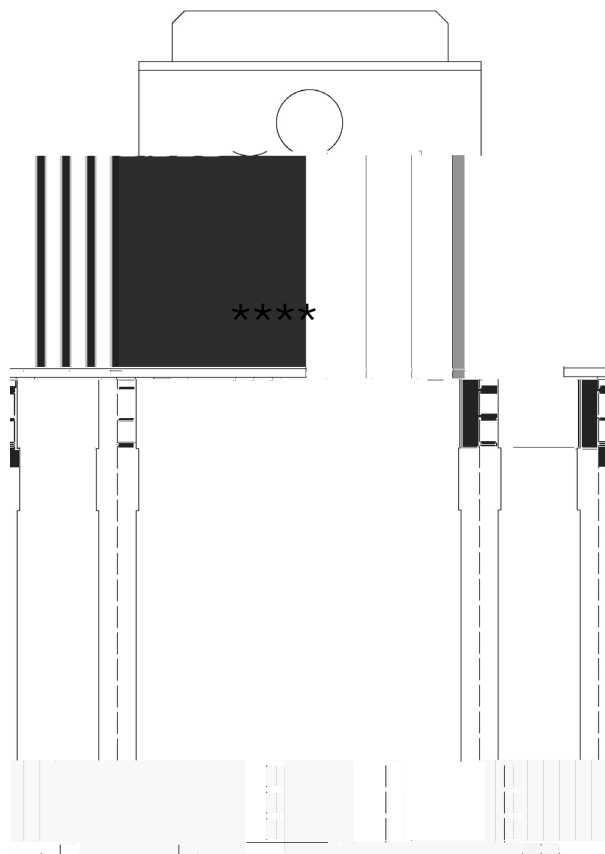
BRI4N60



/ Package Dimensions



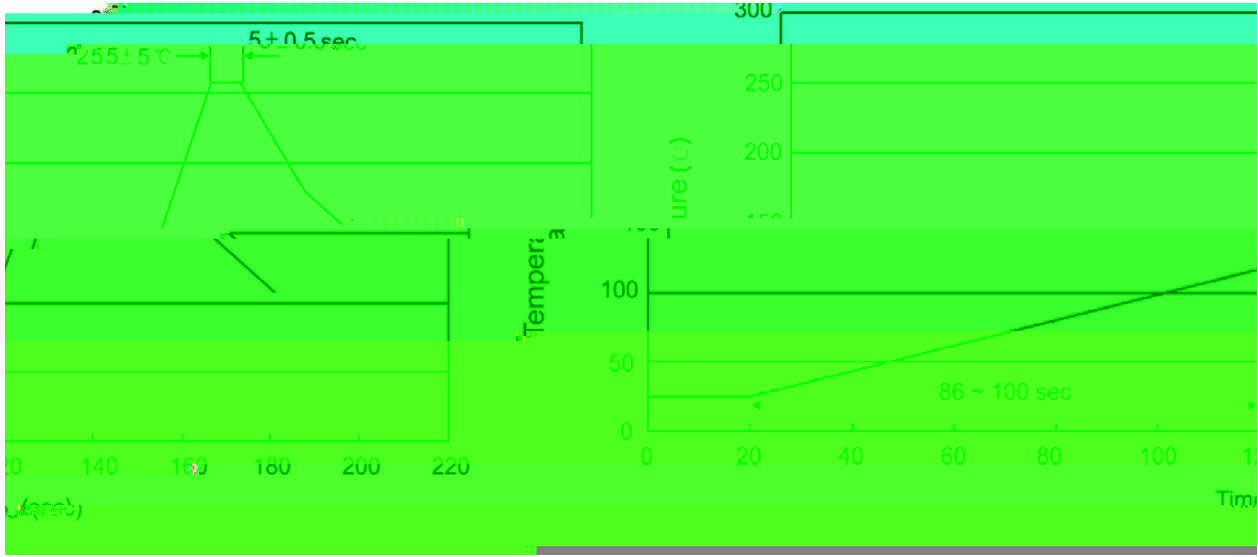
/ Marking Instructions



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() / Temperature Profile for Dip Soldering(Pb-Free)



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/ Resistance to Soldering Heat Test Conditions

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/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Bag 只/袋	Bags/Inner Box 袋/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Bag 袋	Inner Box 盒	Outer Box 箱
TO-251	1,000	10	10,000	5	50,000	135×190	237×172×102	560×245×195

封装形式	Units/Tube 只/套管	包装数量	包装尺寸 :
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